

# Abstracts

## **ESD protection of RF circuits in standard CMOS process (2002 Vol. I [MWSYM])**

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*K. Higashi, A.O. Adan, M. Fukumi, N. Tanba, T. Yoshimasu and M. Hayashi. "ESD protection of RF circuits in standard CMOS process (2002 Vol. I [MWSYM])." 2002 MTT-S International Microwave Symposium Digest 02.1 (2002 Vol. I [MWSYM]): 31-34 vol.1.*

The tradeoffs in the ESD protection device for RFCMOS circuits are described, and the characteristics of an SCR-based ESD structure are presented. The parasitic capacitance of the ESD structure is reduced to  $150\text{ fF}$ . RV HBM and 750 V CDM are achieved in a LNA working at 2.5 GHz with  $\text{NF} < 4\text{ dB}$ , applicable for Bluetooth wireless transceiver.

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